

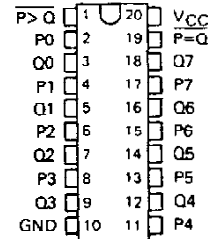
# SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688, SN74LS682, SN74LS684 THRU SN74LS688 8-BIT MAGNITUDE/IDENTITY COMPARATORS

D2617, JANUARY 1981—REVISED MARCH 1988

SDLS008

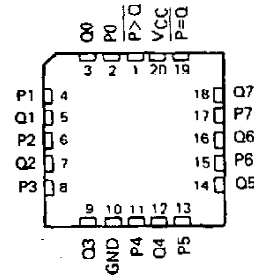
- Compares Two-8-Bit Words
- Choice of Totem-Pole or Open-Collector Outputs
- Hysteresis at P and Q Inputs
- 'LS682 has 20-kΩ Pullup Resistors on the Q Inputs
- SN74LS686 and 'LS687 . . . JT and NT 24-Pin, 300-Mil Packages

SN54LS682, SN54LS684, SN54LS685 . . . J PACKAGE  
SN74LS682, SN74LS684, SN74LS685 . . . DW OR N PACKAGE  
(TOP VIEW)

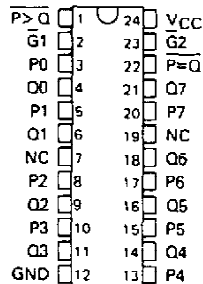


TYPE	P = Q	P > Q	OUTPUT ENABLE	OUTPUT CONFIGURATION	20-kΩ PULLUP
'LS682	yes	yes	no	totem-pole	yes
'LS684	yes	yes	no	totem-pole	no
'LS685	yes	yes	no	open-collector	no
SN74LS686	yes	yes	yes	totem-pole	no
'LS687	yes	yes	yes	open-collector	no
'LS688	yes	no	yes	totem-pole	no

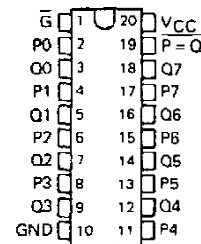
SN54LS682, SN54LS684, SN54LS685 . . . FK PACKAGE  
(TOP VIEW)



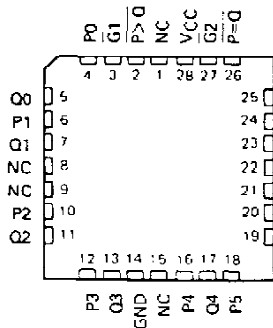
SN54LS687 . . . JT PACKAGE  
SN74LS686, SN74LS687 . . . DW OR NT PACKAGE  
(TOP VIEW)



SN54LS688 . . . J PACKAGE  
SN74LS688 . . . DW OR N PACKAGE  
(TOP VIEW)

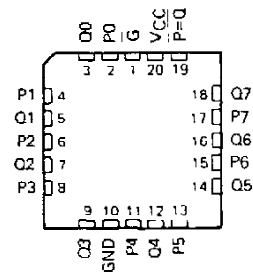


SN54LS687 . . . FK PACKAGE  
(TOP VIEW)



NC—No internal connection

SN54LS688 . . . FK PACKAGE  
(TOP VIEW)



PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

# SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688 SN74LS682, SN74LS684 THRU SN74LS688 8-BIT MAGNITUDE/IDENTITY COMPARATORS

## description

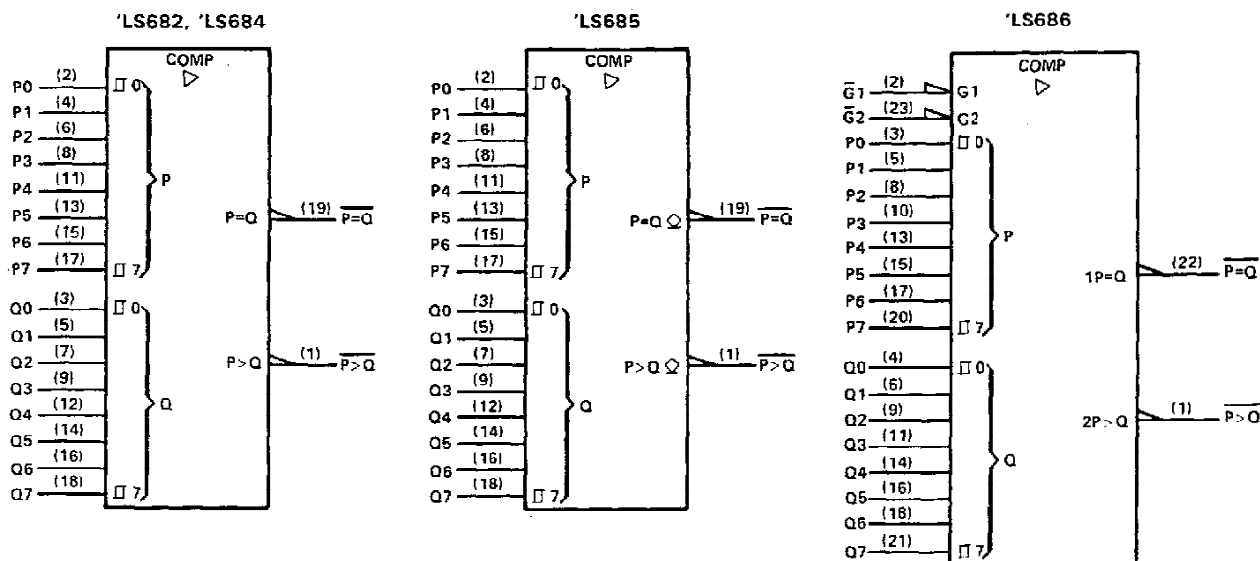
These magnitude comparators perform comparisons of two eight-bit binary or BCD words. All types provide  $\overline{P=Q}$  outputs and all except 'LS688 provide  $\overline{P>Q}$  outputs as well. The 'LS682, 'LS684, 'LS686, and 'LS688 have totem-pole outputs, while the 'LS685 and 'LS687 have open-collector outputs. The 'LS682 features 20-k $\Omega$  pullup termination resistors on the Q inputs for analog or switch data.

FUNCTION TABLE

DATA P, Q	ENABLES		OUTPUTS	
	$\overline{G1}$ , $\overline{G1}$	$\overline{G2}$	$\overline{P=Q}$	$\overline{P>Q}$
P=Q	L	X	L	H
P>Q	X	L	H	L
P<Q	X	X	H	H
P=Q	H	X	H	H
P>Q	X	H	H	H
X	H	H	H	H

- NOTES: 1. The last three lines of the function table applies only to the devices having enable inputs, i.e., 'LS686 thru 'LS688.
2. The  $\overline{P<Q}$  function can be generated by applying the  $\overline{P=Q}$  and  $\overline{P>Q}$  outputs to a 2-input NAND gate.
3. For 'LS686 and 'LS687,  $\overline{G1}$  enables  $\overline{P=Q}$  and  $\overline{G2}$  enables  $\overline{P>Q}$ .

## logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, JT, N, and NT packages.

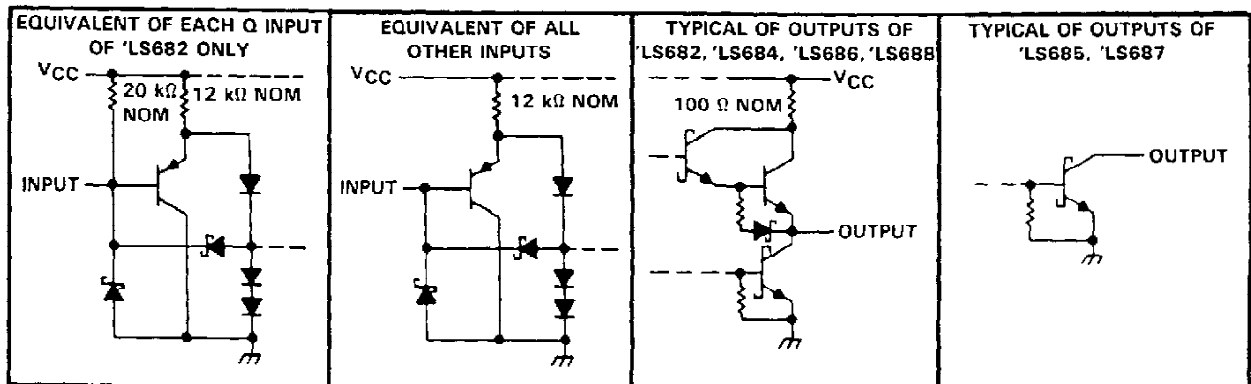
**SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688,  
SN74LS682, SN74LS684 THRU SN74LS688  
8-BIT MAGNITUDE/IDENTITY COMPARATORS**

logic symbols† (continued)



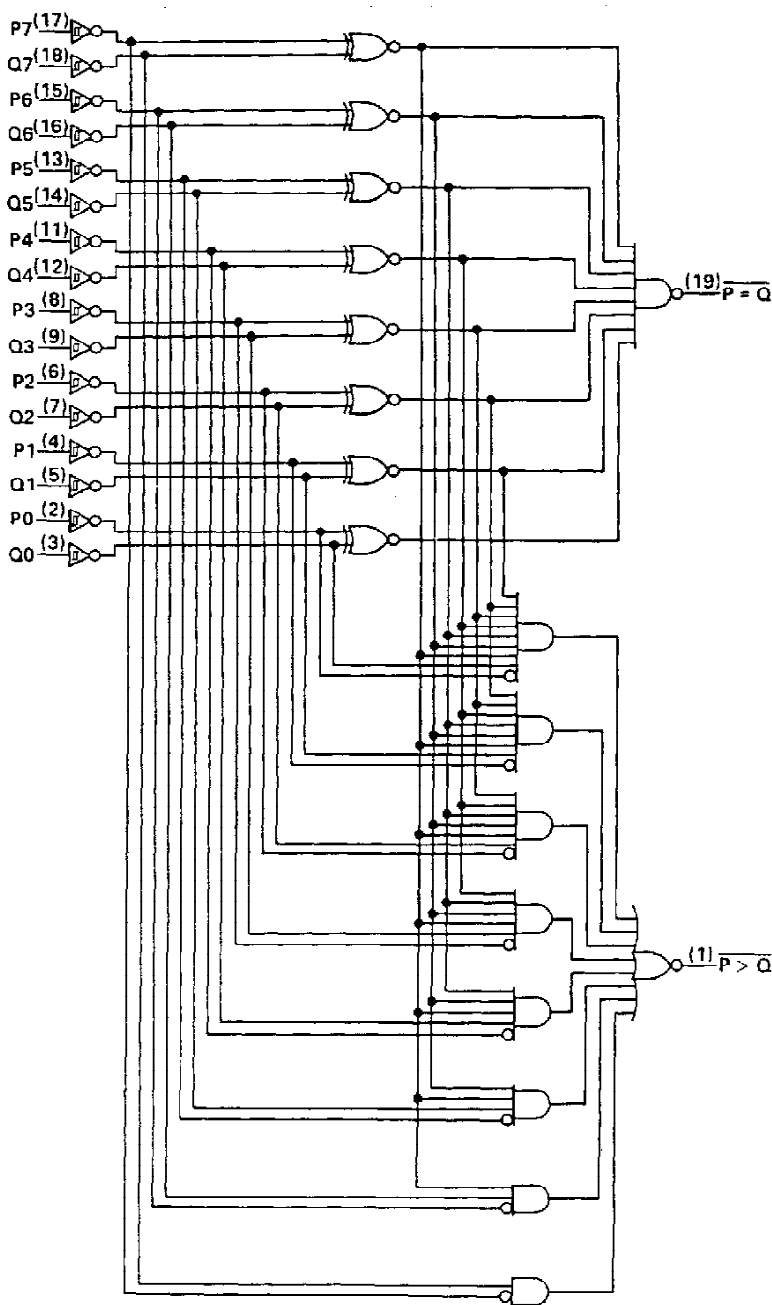
†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, JT, N, and NT packages.

**schematics of inputs and outputs**



**SN54LS682, SN54LS684, SN54LS685  
 SN74LS682, SN74LS684, SN74LS685  
 8-BIT MAGNITUDE/IDENTITY COMPARATORS**

LS682, LS684, LS685 logic diagram (positive logic)



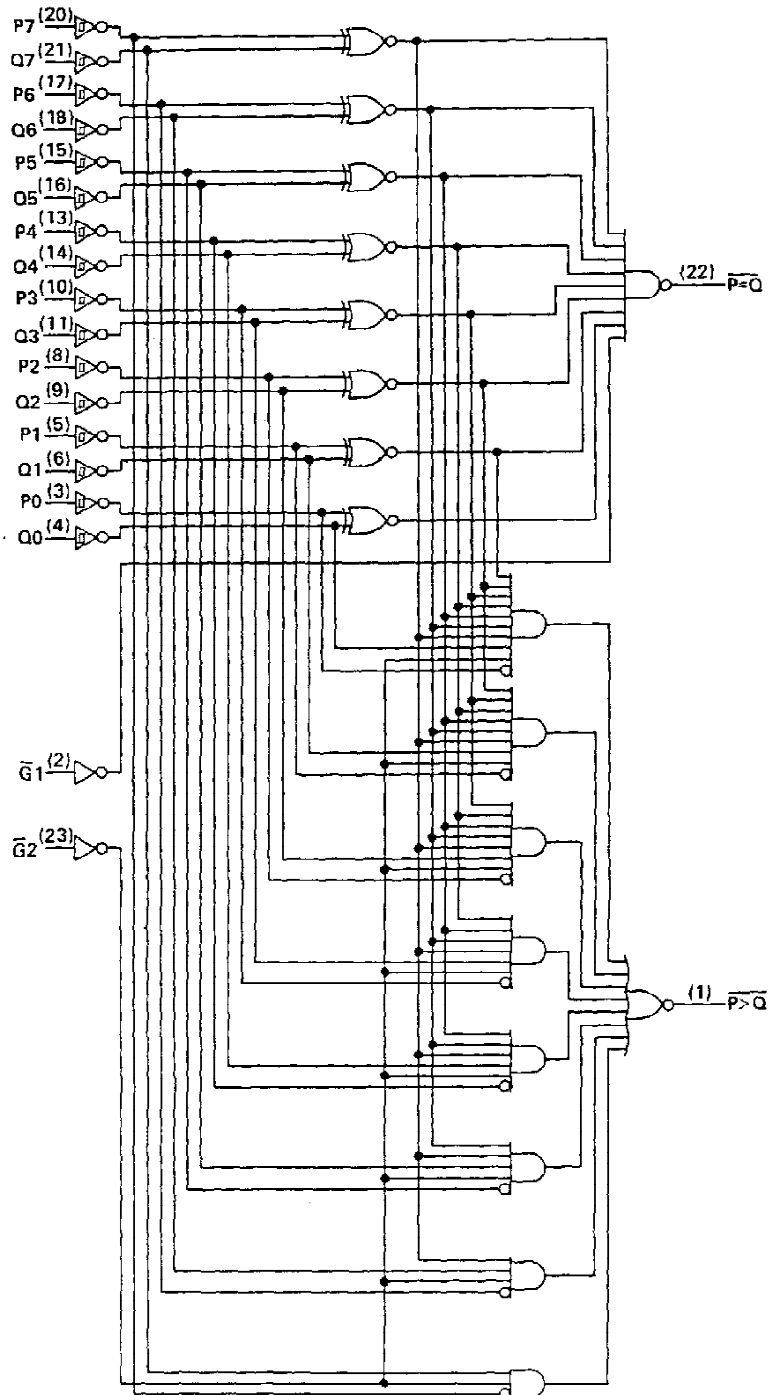
Pin numbers shown are for DW, J, and N packages.

**TEXAS**   
**INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

**SN54LS687**  
**SN74LS686, SN74LS687**  
**8-BIT MAGNITUDE/IDENTITY COMPARATORS**

'LS686, 'LS687 logic diagram (positive logic)



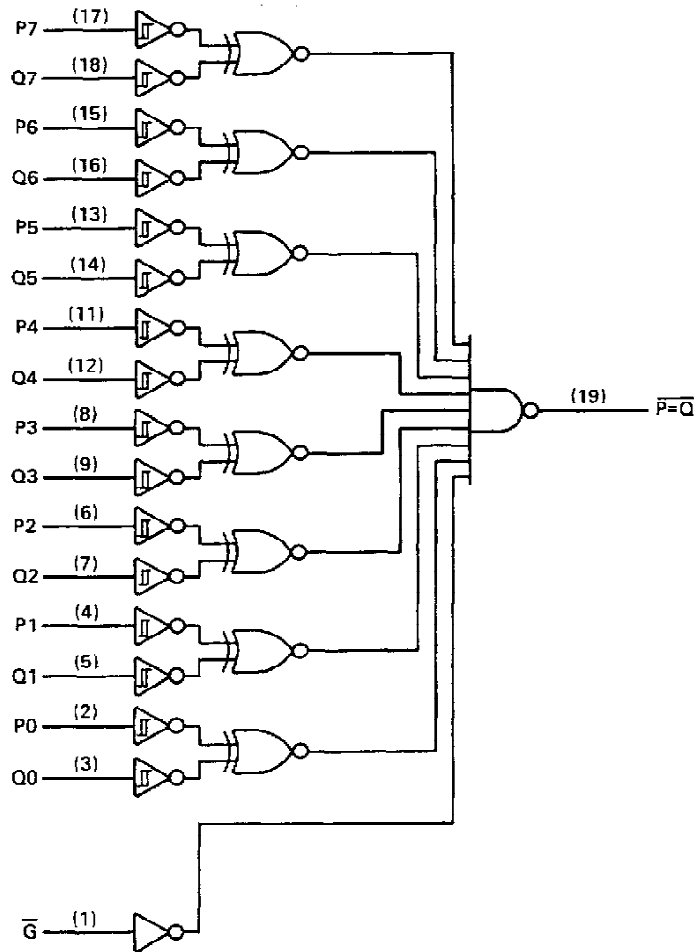
Pin numbers shown are for DW, JT, and NT packages.

  
**TEXAS**  
**INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

**SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688  
SN74LS682, SN74LS684 THRU SN74LS688  
8-BIT IDENTITY COMPARATORS**

'LS688 logic diagram (positive logic)



Pin numbers shown are for DW, J, and N packages.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage: Q inputs of 'LS682	5.5 V
All other inputs	7 V
Off-state output voltage: 'LS685, 'LS687	7 V
Operating free-air temperature range:	
SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688	-55 °C to 125 °C
SN74LS682, SN74LS684 thru SN74LS688	0 °C to 70 °C
Storage temperature range	-65 °C to 150 °C

NOTE 1: Voltage values are with respect to network ground terminal.

**SN54LS682, SN54LS684, SN54LS688  
SN74LS682, SN74LS684, SN74LS686, SN74LS688  
8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS**

**recommended operating conditions**

	SN54LS'			SN74LS'			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	4.5	5	5.5	4.85	5	5.25	V
High-level output current, $I_{OH}$			-400			-400	$\mu$ A
Low-level output current, $I_{OL}$			12			24	mA
Operating free-air temperature, $T_A$	-55		125	0		70	$^{\circ}$ C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS†	SN54LS'		SN74LS'		UNIT	
			MIN	TYP‡	MAX	MIN		TYP‡
$V_{IH}$	High-level input voltage		2		2		V	
$V_{IL}$	Low-level input voltage			0.7		0.8	V	
$V_{T+} - V_{T-}$	Hysteresis	P or Q inputs		0.4		0.4	V	
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}$				-1.5	V	
$V_{OH}$	High-level output voltage	$V_{CC} = \text{MIN}$ , $V_{IH} = 2 \text{ V}$ , $V_{IL} = V_{IL\text{max}}$ , $I_{OH} = -400 \mu\text{A}$	2.5		2.7		V	
$V_{OL}$	Low-level output voltage	$V_{CC} = \text{MIN}$ , $V_{IH} = 2 \text{ V}$ , $V_{IL} = V_{IL\text{max}}$	$I_{OL} = 12 \text{ mA}$	0.25	0.4	0.25	0.4	V
			$I_{OL} = 24 \text{ mA}$			0.35	0.5	
$I_I$	Input current at maximum input voltage	Q inputs, 'LS682	$V_{CC} = \text{MAX}$ , $V_I = 5.5 \text{ V}$					mA
		All other inputs	$V_{CC} = \text{MAX}$ , $V_I = 7 \text{ V}$		0.1		0.1	
$I_{IH}$	High-level input current		$V_{CC} = \text{MAX}$ , $V_I = 2.7 \text{ V}$		20		20	$\mu$ A
$I_{IL}$	Low-level input current	Q inputs, 'LS682	$V_{CC} = \text{MAX}$ , $V_I = 0.4 \text{ V}$		-0.4		-0.4	mA
		All other inputs			-0.2		-0.2	
$I_{OS}^{\S}$	Short-circuit output current		$V_{CC} = \text{MAX}$ , $V_O = 0$	-20	-100	-20	-100	mA
$I_{CC}$	Supply current	'LS682	$V_{CC} = \text{MAX}$ , See Note 1	42	70	42	70	mA
		'LS684		40	65	40	65	
		'LS686		44	75	44	75	
		'LS688		40	65	40	65	

† For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 1:  $I_{CC}$  is measured with any  $\bar{Q}$  inputs grounded, all other inputs at 4.5 V, and all outputs open.

  
**TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

**SN54LS682, SN54LS684, SN54LS688**  
**SN74LS682, SN74LS684, SN74LS686, SN74LS688**  
**8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS**

switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER†	FROM (INPUTS)	TO (OUTPUT)	TEST CONDITIONS	'LS682		'LS684		'LS686		'LS688		UNIT
				MIN	TYP MAX	MIN	TYP MAX	MIN	TYP MAX	MIN	TYP MAX	
$t_{PLH}$	P	$\overline{P=Q}$	$R_L = 667\ \Omega$ , $C_L = 45\ \text{pF}$ , All other inputs low, See Note 2	13	25	15	25	13	25	12	18	ns
$t_{PHL}$				15	25	17	25	20	30	17	23	
$t_{PLH}$	Q	$\overline{P=Q}$		14	25	16	25	13	25	12	18	ns
$t_{PHL}$				15	25	15	25	21	30	17	23	
$t_{PLH}$	$\overline{Q}, \overline{Q}1$	$\overline{P=Q}$						11	20	12	18	ns
$t_{PHL}$								19	30	13	20	
$t_{PLH}$	P	$\overline{P>Q}$			20	30	22	30	19	30		ns
$t_{PHL}$					15	30	17	30	15	30		
$t_{PLH}$	Q	$\overline{P>Q}$			21	30	24	30	18	30		ns
$t_{PHL}$					19	30	20	30	19	30		
$t_{PLH}$	$\overline{Q}2$	$\overline{P>Q}$						21	30		ns	
$t_{PHL}$								16	25			

† $t_{PLH}$  = propagation delay time, low-to-high-level outputs;  $t_{PHL}$  = propagation delay time, high-to-low-level output.  
 NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



**SN54LS685, SN54LS687**  
**SN74LS685, SN74LS687, SN74LS688**

**8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS**

**recommended operating conditions**

	SN54LS <sup>†</sup>			SN74LS <sup>†</sup>			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	4.5	5	5.5	4.85	5	5.25	V
High-level output current, $I_{OH}$			5.5			5.5	V
Low-level output current, $I_{OL}$			12			24	mA
Operating free-air temperature, $T_A$	-55		125	0		70	°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS <sup>†</sup>	SN54LS <sup>†</sup>			SN74LS <sup>†</sup>			UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX		
$V_{IH}$	High-level input voltage		2			2			V	
$V_{IL}$	Low-level input voltage				0.7			0.8	V	
$V_{T+} - V_{T-}$	Hysteresis	P or Q inputs	0.4			0.4			V	
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$			-1.5			-1.5	V	
$I_{OH}$	High-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{ILmax}, V_{OH} = 5.5 \text{ V}$			250			100	$\mu\text{A}$	
$V_{OL}$	Low-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{ILmax}$	$I_{OL} = 12 \text{ mA}$		0.25	0.4	$I_{OL} = 12 \text{ mA}$		0.25	0.4
			$I_{OL} = 24 \text{ mA}$				$I_{OL} = 24 \text{ mA}$		0.35	0.5
$I_I$		$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$			0.1			0.1	mA	
$I_{IH}$	High-level input current	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			20			20	$\mu\text{A}$	
$I_{IL}$	Low-level input current	$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$			-0.2			-0.2	mA	
$I_{CC}$	Supply current	$V_{CC} = \text{MAX},$ See Note 1	'LS685		40	65	'LS687		40	65
			'LS687		44	75	'LS687		44	75

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ .

NOTE 1:  $I_{CC}$  is measure with any  $\bar{Q}$  inputs grounded, all other inputs at 4.5 V, and all outputs open.

**SN54LS685, SN54LS687**  
**SN74LS685, SN74LS687**  
**8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH OPEN-COLLECTOR OUTPUTS**

switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS685			'LS687			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
$t_{PLH}$	P	$\overline{P=Q}$	$R_L = 667\ \Omega$ , $C_L = 45\ \text{pF}$ , All other inputs low, See Note 2	30	45		24	35	ns	
$t_{PHL}$				19	35		20	30		
$t_{PLH}$	Q	$\overline{P=Q}$		24	45		24	35	ns	
$t_{PHL}$				23	35		20	30		
$t_{PLH}$	$\overline{Q}, \overline{Q1}$	$\overline{P=Q}$					21	35	ns	
$t_{PHL}$							18	30		
$t_{PLH}$	P	$\overline{P>Q}$			32	45		24	35	ns
$t_{PHL}$					16	35		16	30	
$t_{PLH}$	Q	$\overline{P>Q}$			30	45		24	35	ns
$t_{PHL}$					20	35		16	30	
$t_{PLH}$	$\overline{Q2}$	$\overline{P>Q}$				24	35	ns		
$t_{PHL}$						15	30			

$t_{PLH}$  = propagation delay time, low-to-high-level outputs;  $t_{PHL}$  = propagation delay time, high-to-low-level output.  
 NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
8415101RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101RA SNJ54LS682J	<a href="#">Samples</a>
8415101SA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101SA SNJ54LS682W	<a href="#">Samples</a>
8415101SA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101SA SNJ54LS682W	<a href="#">Samples</a>
84152012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84152012A SNJ54LS 684FK	<a href="#">Samples</a>
8415201RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415201RA SNJ54LS684J	<a href="#">Samples</a>
84153012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84153012A SNJ54LS 688FK	<a href="#">Samples</a>
8415301RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415301RA SNJ54LS688J	<a href="#">Samples</a>
8415301SA	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415301SA SNJ54LS688W	<a href="#">Samples</a>
SN54LS682J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS682J	<a href="#">Samples</a>
SN54LS682J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS682J	<a href="#">Samples</a>
SN54LS684J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS684J	<a href="#">Samples</a>
SN54LS688J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS688J	<a href="#">Samples</a>
SN74LS682DW	LIFEBUY	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS682	
SN74LS682DW	LIFEBUY	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS682	
SN74LS682DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS682	<a href="#">Samples</a>
SN74LS682DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS682	<a href="#">Samples</a>
SN74LS682N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS682N	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS682N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS682N	<a href="#">Samples</a>
SN74LS682NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS682	<a href="#">Samples</a>
SN74LS682NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS682	<a href="#">Samples</a>
SN74LS684DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS684	<a href="#">Samples</a>
SN74LS684N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS684N	<a href="#">Samples</a>
SN74LS684NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS684	<a href="#">Samples</a>
SN74LS688DW	LIFEBUY	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS688	
SN74LS688DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS688	<a href="#">Samples</a>
SN74LS688N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS688N	<a href="#">Samples</a>
SN74LS688NE4	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS688N	<a href="#">Samples</a>
SN74LS688NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS688	<a href="#">Samples</a>
SNJ54LS682J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101RA SNJ54LS682J	<a href="#">Samples</a>
SNJ54LS682J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101RA SNJ54LS682J	<a href="#">Samples</a>
SNJ54LS682W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101SA SNJ54LS682W	<a href="#">Samples</a>
SNJ54LS682W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415101SA SNJ54LS682W	<a href="#">Samples</a>
SNJ54LS684FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84152012A SNJ54LS 684FK	<a href="#">Samples</a>
SNJ54LS684J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415201RA SNJ54LS684J	<a href="#">Samples</a>
SNJ54LS688FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84153012A SNJ54LS 688FK	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS688J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415301RA SNJ54LS688J	<a href="#">Samples</a>
SNJ54LS688W	ACTIVE	CFP	W	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8415301SA SNJ54LS688W	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LS682, SN54LS684, SN54LS688, SN74LS682, SN74LS684, SN74LS688 :**

- Catalog : [SN74LS682](#), [SN74LS684](#), [SN74LS688](#)
- Military : [SN54LS682](#), [SN54LS684](#), [SN54LS688](#)

## NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

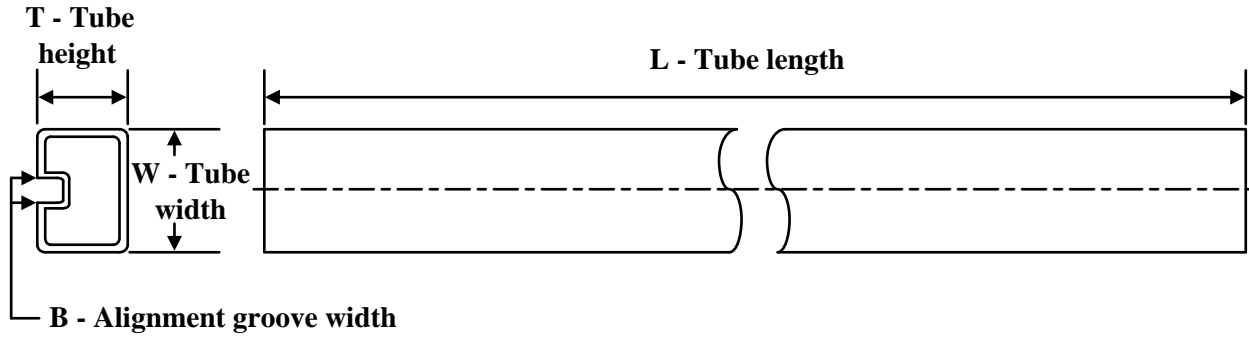
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS682DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS682NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74LS684DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS684NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74LS688DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS688NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS682DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS682NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74LS684DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS684NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74LS688DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS688NSR	SO	NS	20	2000	367.0	367.0	45.0



**TUBE**


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
8415101SA	W	CFP	20	1	506.98	26.16	6220	NA
84152012A	FK	LCCC	20	1	506.98	12.06	2030	NA
84153012A	FK	LCCC	20	1	506.98	12.06	2030	NA
8415301SA	W	CFP	20	1	506.98	26.16	6220	NA
SN74LS682DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74LS682N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS684N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS688DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74LS688N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS688NE4	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54LS682W	W	CFP	20	1	506.98	26.16	6220	NA
SNJ54LS684FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS688FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS688W	W	CFP	20	1	506.98	26.16	6220	NA

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## GENERIC PACKAGE VIEW

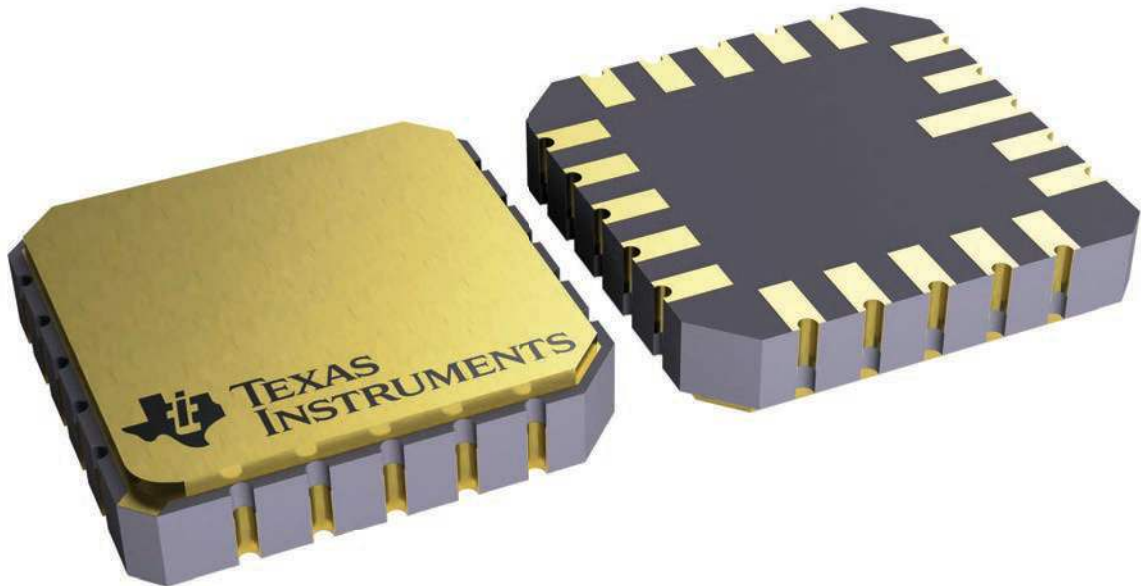
**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - $\triangle D$  The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

- All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

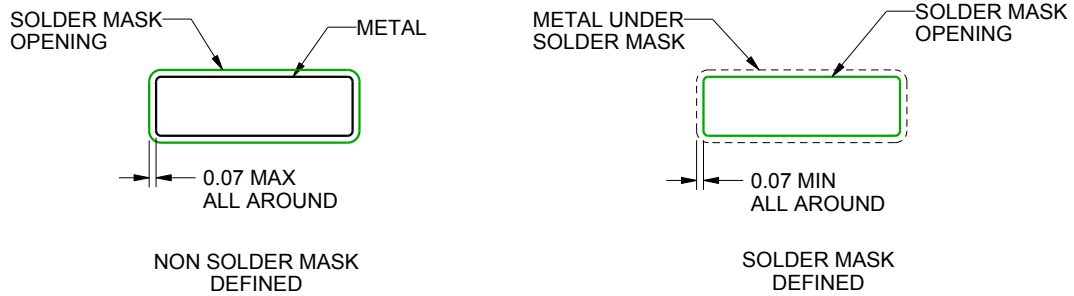
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

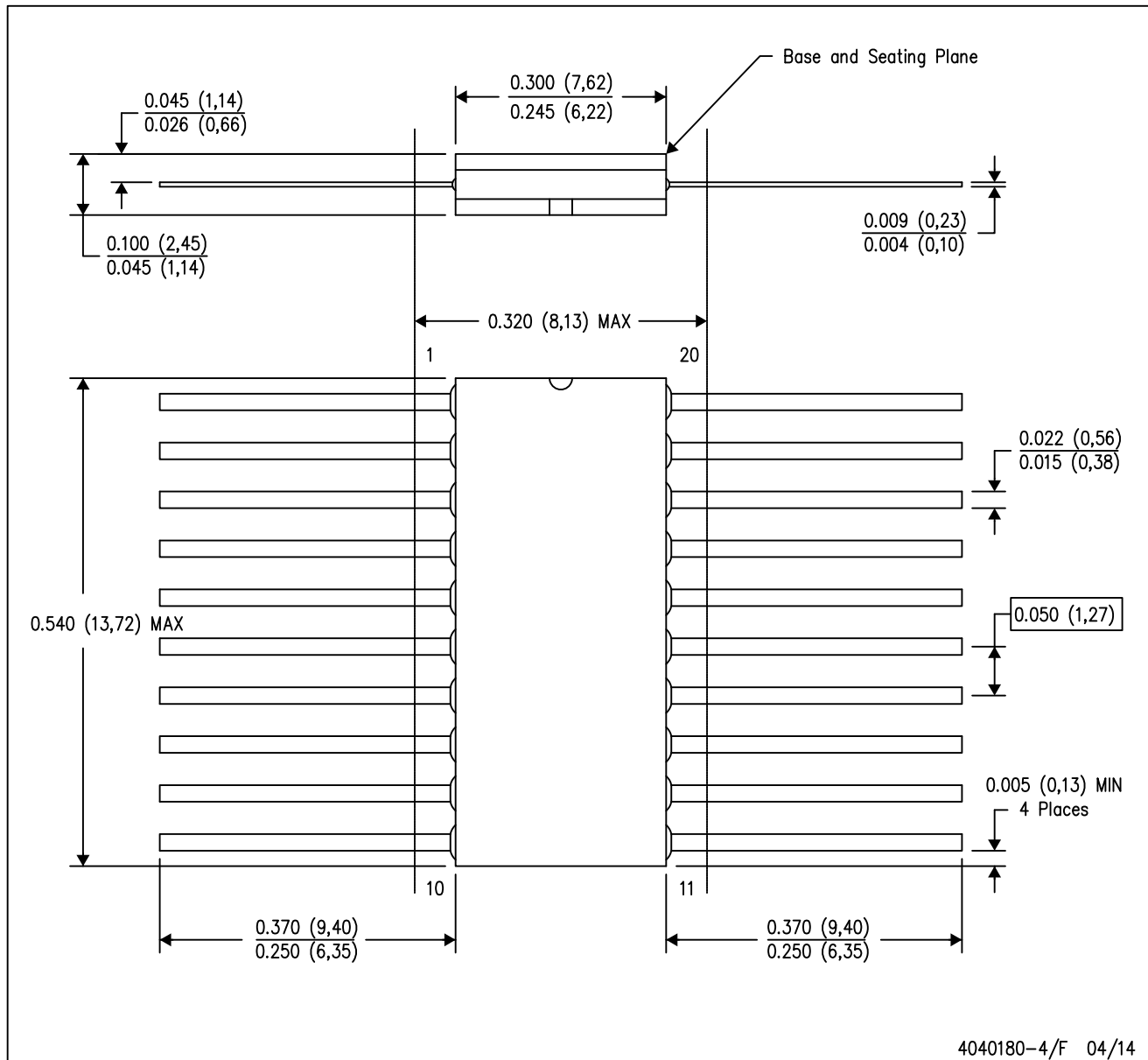
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2023, Texas Instruments Incorporated